

PTC thermistors as inrush current limiters

PTC thermistors in housing

 Series/Type:
 B59***J0130A020

 Date:
 April 2019

The following products presented in this data sheet are being withdrawn.

Ordering Code		Date of Withdrawal	Deadline Last Orders	Last Shipments
B59109J0130A020	B59219J0130A020	2019-03-01	2019-06-07	2019-09-07
B59107J0130A020	B59217J0130A020	2019-03-01	2019-06-07	2019-09-07
B59105J0130A020	B59215J0130A020	2019-03-01	2019-06-07	2019-09-07

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PTC thermistors in housing

Applications

- Inrush current limiter for smoothing and DC link capacitors
- To replace high-power fixed resistors for capacitor charging

Features

- Self-protecting in case of malfunction of short-circuit relay or internal short circuit of capacitor
- Encased thermistor disk with clamp contacts for high reliability
- For high pulse currents and a high number of operating cycles
- Inrush current limiters are not damaged when directly connected to V_{max} even without additional current limitation
- Flame-retardant plastic case
- Case material UL-listed
- Sn-plated lead-free solder pins
- Manufacturer's logo, type designation and date code YYWW stamped on in white (YYWWD for tpye J103)
- Types J213, J215, J217 and J219 qualification based on AEC-Q200, Rev. D
- UL approval for all types to UL 1434 (file number E69802)
- VDE approval for all types (licence number 40040539)
- IECQ certificate for all types (file number 101-QA-13)
- RoHS-compatible

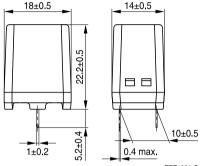
Delivery mode

Packed in carton box

General technical data

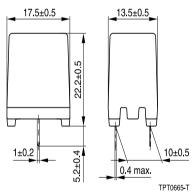
Dimensional drawings

Type J213, J215, J217 and J219



TPT1061-C

Type J105, J107 and J109



Dimensions in mm

Operating cycles at V _{max}	(charging of capacitor)	N _c	> 100000	cycles
Switching cycles at V _{max}	(failure mode)	N _f	> 100	cycles
Operating temperature range	(V = 0)	T _{op}	-40/+125	°C
Operating temperature range	$(V = V_{max})$	T _{op}	-20/+85	°C



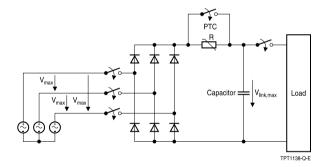
PTC thermistors in housing

Туре	V _{max}	$V_{\text{link,max}}$	R _R	ΔR_{R}	T _{ref}	C _{th}	$ au_{th}$	Circuit	Ordering code
					(typ.)	(typical)	(typical)	diagram	
	V AC	V DC	Ω	%	°C	J/K	s		
PBT pl	astic ca	se, prefe	rred typ	pes for r	new design	S			
J213	280	400	33	25	130	1.1	140	2	B59213J0130A020
J215	280	400	22	25	130	2.3	150	2	B59215J0130A020
J217	440	620	56	25	130	2.3	150	1, 2, 3	B59217J0130A020
J219	560	800	100	25	130	2.3	150	1, 2, 3	B59219J0130A020
Pheno	lic resin	plastic ca	ase						
J105	280	400	22	25	130	2.3	150	2	B59105J0130A020
J107	440	620	56	25	130	2.3	150	1, 2, 3	B59107J0130A020
J109	560	800	100	25	130	2.3	150	1, 2, 3	B59109J0130A020

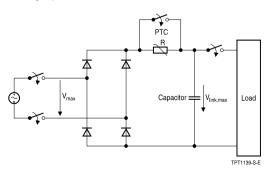
Electrical specifications and ordering codes

Circuit diagrams

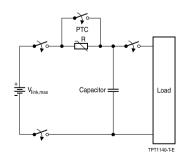
① Three phases circuit



2 Single phase circuit



3 DC circuit



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PTC thermistors in housing

Calculation of the number of required PTC elements

Number of required PTC elements (connected in parallel) as function of capacitance and charging voltage of smoothing or DC link capacitor:

$$N \geq \frac{K \cdot C \cdot V^2}{2 \cdot C_{th} \cdot (T_{ref} - T_{A,max})}$$

К	K factor
	K = 1 for DC source
	K = 0.96 for 3-phase bridge rectifier
	K = 0.76 for single phase bridge rectifier
N	Number of required PTC thermistors connected in parallel
С	Capacitance of smoothing or DC link capacitor in F
V	Charging voltage of capacitor in V
C _{th}	Heat capacity in J/K
T _{ref}	Reference temperature of PTC in °C
T _{A,max}	Expected maximum ambient temperature in °C

In case of large N values the resulting resistance of the parallel PTC network might be too low for effective limitation of the charging current. In this case a combination of series and parallel connected PTC thermistors can be used.



PTC thermistors in housing

Reliability data

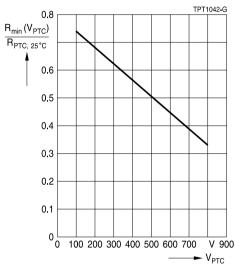
Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,		Room temperature, V _{link,max}	< 25%
cycling		applied energy < $C_{th} \cdot (T_{ref} - T_A)$	
		Number of cycles: 100 000	
Electrical endurance,	IEC 60738-1	Storage at V_{max} and $T_{op,max}$ (@ V_{max})	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 V), T_2 = T_{op,max} (0 V)$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration	IEC 60738-1	Frequency range: 10 to 55 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: 3×2 h	
		Test according to IEC 60068-2-6, test Fc	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max} (0 V)$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 V)$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	



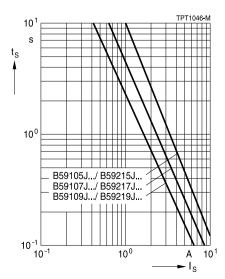
PTC thermistors in housing

Characteristics

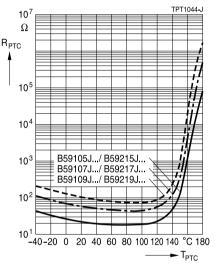
Minimum resistance of PTC thermistors versus applied voltage (pulsed)



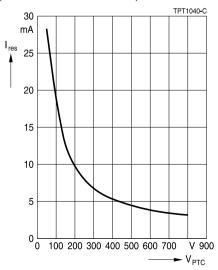
Switching time t_s versus switching current I_s (measured at 25 °C in still air)



PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



Residual current in high-ohmic state I_{res} as function of applied voltage V_{PTC} , typical (measured at 25 °C in still air)



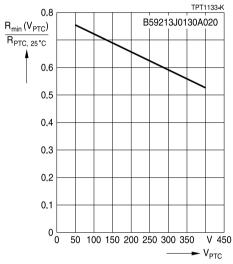
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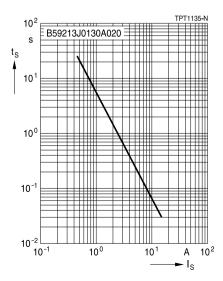
PTC thermistors in housing

Characteristics for type J213

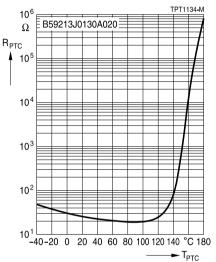
Minimum resistance of PTC thermistors versus applied voltage (pulsed)



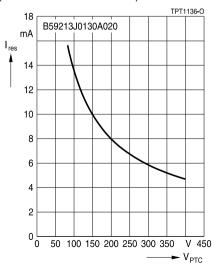
Switching time t_s versus switching current I_s (measured at 25 °C in still air)



PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



Residual current in high-ohmic state I_{res} as function of applied voltage V_{PTC} , typical (measured at 25 °C in still air)



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PTC thermistors in housing

Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package prior to processing.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 1210 and smaller: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- The ceramic and metallization of the components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



PTC thermistors in housing

Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force and pressure of the clamping contacts pressing against the PTC must be 10 N and 50 kPa, respectively. In case the assembly is exposed to mechanical shock and/ or vibration this force should be higher in order to avoid movement of the PTC during operation.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

Display of ordering codes for EPCOS products

The ordering code for one and the same EPCOS product can be represented differently in data sheets, data books, other publications, on the EPCOS website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes



PTC thermistors in housing

Symbols and terms

Symbol	Term
A	Area
С	Capacitance
C _{th}	Heat capacity
f	Frequency
I	Current
I _{max}	Maximum current
I _R	Rated current
I _{res}	Residual current
I _{PTC}	PTC current
l _r	Residual currrent
l _{r,oil}	Residual currrent in oil (for level sensors)
I _{r,air}	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
I _s	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
Ν	Number (integer)
N _c	Operating cycles at V _{max} , charging of capacitor
N _f	Switching cycles at V _{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P _{el}	Electrical power
P_{diss}	Dissipation power
R _G	Generator internal resistance
R _{min}	Minimum resistance
R _R	Rated resistance @ rated temperature T _R
ΔR_{R}	Tolerance of R _R
R _P	Parallel resistance
R _{PTC}	PTC resistance
R _{ref}	Reference resistance
Rs	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R ₂₅



PTC thermistors in housing

tInterpretationtTime T_A Ambient temperature t_a Thermal threshold time T_C Ferroelectric Curie temperature t_e Settling time (for level sensors) T_R Rated temperature @ 25 °C or otherwise specified in the data sheet T_{ence} Sensing temperature T_{op} Operating temperature T_{op} Operating temperature T_{ref} Response time T_{ref} Reference temperature T_{ref} Reference temperature T_{min} Temperature at minimum resistance t_s Switching time T_{surf} Surface temperatureUCTUpper category temperatureV or V_{ai} Voltage (with subscript only for distinction from volume) V_{ermax} Maximum DC charge voltage of the surge generator V_{ermax} Maximum voltage applied at fault conditions in protection mode V_{max} Maximum voltage V_{max} Maximum ink voltage V_{max} Maximum ink voltage V_{max} Maximum operating voltage V_{max} Maximum operating voltage V_{max} Maximum measuring voltage V_{max} Maximum measuring voltage V_{rrocos} Voltage drop across a PTC thermistor α Temperature coefficient Δ Tolerance, change δ_{en} Disipation factor τ_{m} Thermal cooling time constant λ Failure rate e Lead spacing (in mm) <th>т</th> <th>Temperature</th>	т	Temperature
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$V_{F,max}$ Maximum voltage applied at fault conditions in protection mode V_{FMS} Root-mean-square value of voltage V_{BD} Breakdown voltage V_{ins} Insulation test voltage V_{ins} Maximum link voltage V_{max} Maximum operating voltage V_{max} Maximum dynamic (short-time) operating voltage V_{meas} Measuring voltage V_{meas} Maximum measuring voltage $V_{reeas,max}$ Maximum contrast of thermistor Q Temperature coefficient Δ Tolerance, change δ_{th} Dissipation factor τ_{th} Thermal cooling time constant λ Failure rate	V or V_{el}	Voltage (with subscript only for distinction from volume)
$\begin{array}{llllllllllllllllllllllllllllllllllll$	$V_{c(max)}$	Maximum DC charge voltage of the surge generator
VacBreakdown voltage V_{BD} Breakdown voltage V_{ins} Insulation test voltage $V_{ins,max}$ Maximum link voltage V_{max} Maximum operating voltage V_{max} Maximum dynamic (short-time) operating voltage $V_{max,dyn}$ Maximum dynamic (short-time) operating voltage $V_{meas,max}$ Measuring voltage $V_{meas,max}$ Maximum measuring voltage V_{PTC} Voltage drop across a PTC thermistor α Temperature coefficient Δ Tolerance, change δ_{th} Dissipation factor τ_{th} Thermal cooling time constant λ Failure rate	$V_{\text{F,max}}$	Maximum voltage applied at fault conditions in protection mode
V_{ins} Insulation test voltage V_{ins} Maximum link voltage V_{max} Maximum operating voltage V_{max} Maximum dynamic (short-time) operating voltage V_{meas} Measuring voltage V_{meas} Maximum measuring voltage $V_{meas,max}$ Maximum measuring voltage V_{PTC} Voltage drop across a PTC thermistor α Temperature coefficient Δ Tolerance, change δ_{th} Dissipation factor τ_{th} Thermal cooling time constant λ Failure rate	V _{RMS}	Root-mean-square value of voltage
$V_{ink,max}$ Maximum link voltage V_{max} Maximum operating voltage $V_{max,dyn}$ Maximum dynamic (short-time) operating voltage V_{meas} Measuring voltage $V_{meas,max}$ Maximum measuring voltage V_{R} Rated voltage V_{PTC} Voltage drop across a PTC thermistor α Temperature coefficient Δ Tolerance, change δ_{th} Dissipation factor τ_{th} Thermal cooling time constant λ Failure rate	V _{BD}	
V_{max} Maximum operating voltage $V_{max,dyn}$ Maximum dynamic (short-time) operating voltage V_{meas} Measuring voltage $V_{meas,max}$ Maximum measuring voltage V_R Rated voltage V_{PTC} Voltage drop across a PTC thermistor α Temperature coefficient Δ Tolerance, change δ_{th} Dissipation factor τ_{th} Thermal cooling time constant λ Failure rate		Insulation test voltage
$\begin{array}{lll} V_{max,dyn} & Maximum dynamic (short-time) operating voltage \\ V_{meas} & Measuring voltage \\ V_{meas,max} & Maximum measuring voltage \\ V_{R} & Rated voltage \\ V_{PTC} & Voltage drop across a PTC thermistor \\ \alpha & Temperature coefficient \\ \Delta & Tolerance, change \\ \delta_{th} & Dissipation factor \\ \tau_{th} & Thermal cooling time constant \\ \lambda & Failure rate \end{array}$	$V_{link,max}$	Maximum link voltage
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$\begin{array}{lll} V_{\text{PTC}} & \mbox{Voltage drop across a PTC thermistor} \\ \alpha & \mbox{Temperature coefficient} \\ \Delta & \mbox{Tolerance, change} \\ \delta_{th} & \mbox{Dissipation factor} \\ \tau_{th} & \mbox{Thermal cooling time constant} \\ \lambda & \mbox{Failure rate} \end{array}$		
$ \begin{array}{llllllllllllllllllllllllllllllllllll$		5
$\begin{array}{llllllllllllllllllllllllllllllllllll$	V _{PTC}	
$δ_{th}$ Dissipation factor $τ_{th}$ Thermal cooling time constant $λ$ Failure rate		
$τ_{th}$ Thermal cooling time constant λ Failure rate		
λ Failure rate	δ_{th}	
		_
Lead spacing (in mm)		
	e	Lead spacing (in mm)



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